



Material Content Data Sheet



Sales Product Name		BFP 720ESD H6327		Issued		22. January 2016		
MA#		MA000796166						
Package		PG-SOT343-4-2		Weight*		6.93 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	noble metal	gold	7440-57-5	0.003	0.04		393	
	non noble metal	tin	7440-31-5	0.001	0.01		101	
	inorganic material	silicon	7440-21-3	0.024	0.34	0.39	3429	3923
leadframe	inorganic material	silicon	7440-21-3	0.001	0.01		100	
	non noble metal	titanium	7440-32-6	0.003	0.05		497	
	non noble metal	chromium	7440-47-3	0.010	0.15		1492	
	non noble metal	copper	7440-50-8	3.433	49.53	49.74	495300	497389
wire	noble metal	gold	7440-57-5	0.011	0.15	0.15	1517	1517
encapsulation	organic material	carbon black	1333-86-4	0.030	0.44		4369	
	plastics	epoxy resin	-	0.651	9.39		93926	
	inorganic material	silicondioxide	60676-86-0	2.347	33.86	43.69	338572	436867
leadfinish	non noble metal	tin	7440-31-5	0.202	2.91	2.91	29103	29103
plating	noble metal	silver	7440-22-4	0.216	3.12	3.12	31201	31201
*deviation	< 10%		Sum in total:			100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
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This product is in compliance with EU Directive 2011/65/EU (RoHS) and does not use any exemption.

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